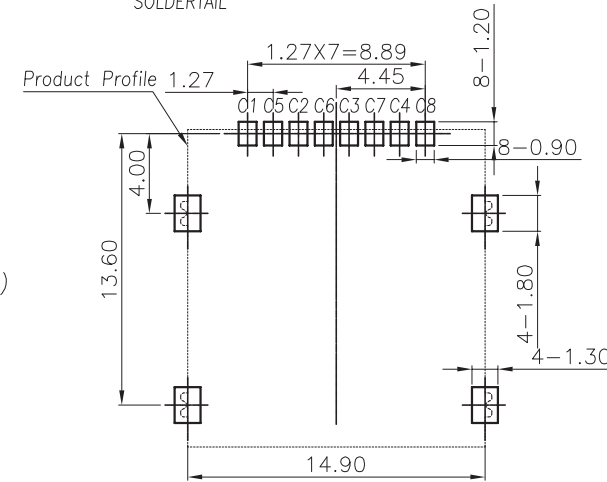
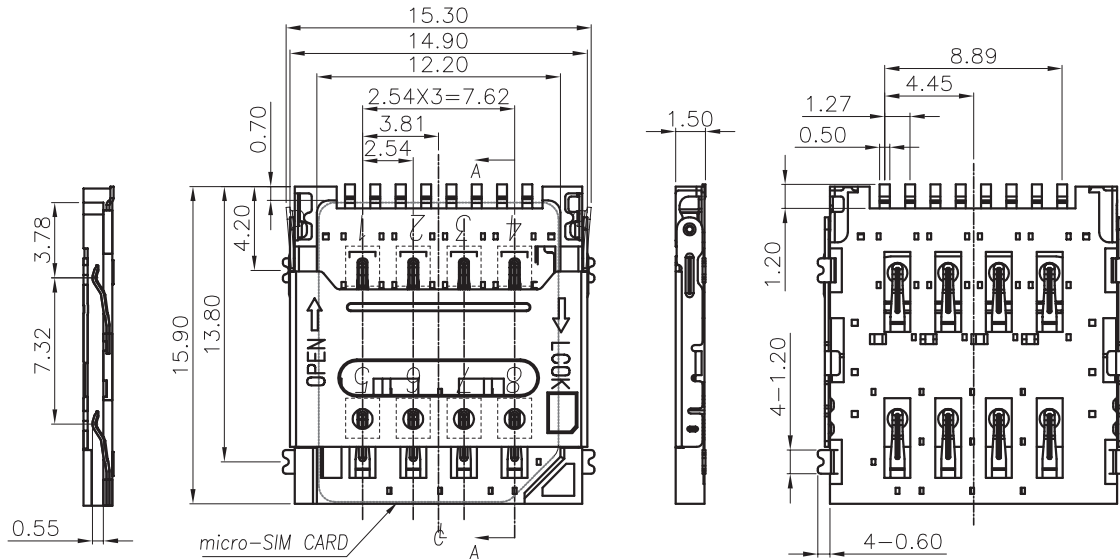


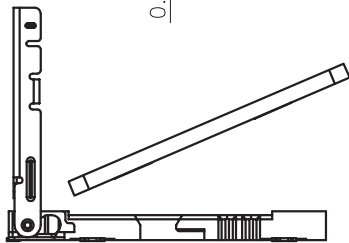
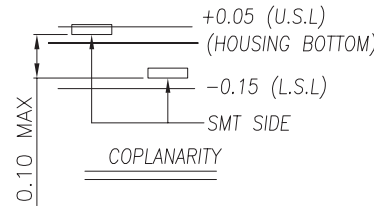
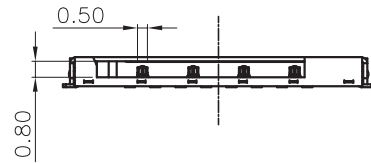
REV.	ECN NO OR DESCRIPTION	REVISED	DATE
▽	PROPOSE ONLY	ALLEN	2013.05.04

NOTES:

- ELECTRICAL CHARACTERISTICS
  - CONTACT RESISTANCE: 60 Milliohms Max
  - INSULATION RESISTANCE: 1,000 Megohms Min.
  - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE.
- MECHANICAL CHARACTERISTICS
  - OPERATION TEMPERATURE RANGE: -25°C~+70°C
  - DURABILITY: 5000 CYCLES
- MATERIAL:
  - HOUSING: THERMOPLASTIC, UL 94-V0
  - TERMINAL: PHOSPHOR BRONZE, T=0.15
  - SHELL: STAINLESS STEEL, T=0.15
- FINISHED:
  - TERMINAL: Ni PLATED UNDER, Au PLATED ON CONTACT AREA, G/F PLATED ON SOLDER TAIL
  - SHELL: Ni PLATED UNDER, G/F PLATED ON SOLDER TAIL



SECTION: A-A



STEP 1 INSERT Micro-SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED

③	TERMINAL	8	C5210-EH, T=0.12	Au 5u" PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.12	AU/Ni PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE

UNLESS OTHERWISE SPECIFIED TOLERANCES

**Wellco T&C Co., Ltd.**

DECIMALS:	ANGLES:	TITLE	8Pin 1.5H HINGE Micro SIM CARD CONN.		
X :±0.5	X :±2'	DWN	ALLEN	PART NO. SOHG-150008-08G	
X.X :±0.20	X.X :±1'	CHKD	KEVIN	SCALE:1:1	UNIT: mm
X.XX :±0.10		APVD	ERIC.W	SIZE: A3	SHEET:10F 1
					REV: A1

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